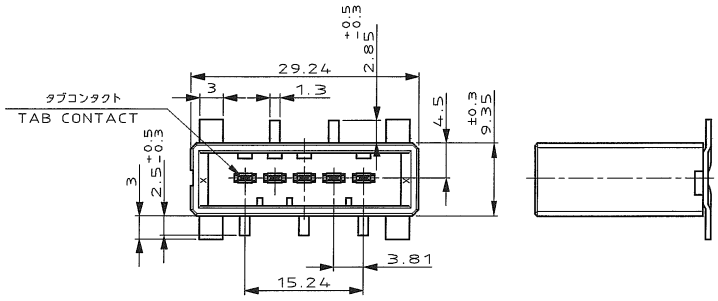
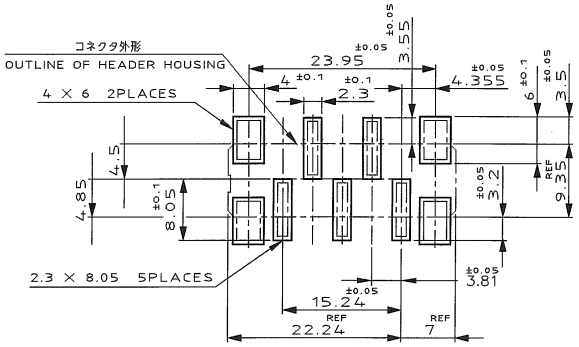
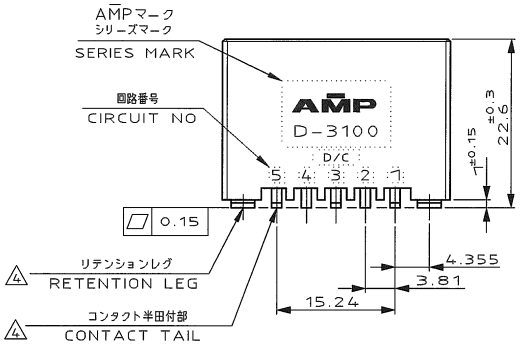




推奨基板取付け寸法
（非累積公差）
（コネクタ搭載面）

RECOMEND BOARD PATTERN
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)



NOTES

1. MATERIAL:HOUSING:GLASS FILED THERMO PLASTIC ,UL94V-0
   CONTACT:COPPER ALLOY
   RETENTION LEG:COPPER ALLOY
2. FINISH(CONTACT AREA):0.38μmMIN GOLD PLATING OVER Ni PLATING
3. FINISH(CONTACT AREA):0.76μmMIN GOLD PLATING OVER Ni PLATING
4. FINISH(RETENTION LEG): TIN PLATED (SOLDER TYING) OVER NICKEL

注記

1. 材料：ハウジング：ガラス入り熱可塑性樹脂 ,UL94V-0
   コンタクト：銅合金
   リテンションレグ：銅合金
2. めっき：コンタクト接触部：ニッケル下地の上に金めっき0.38μmMIN
3. めっき：コンタクト接触部：ニッケル下地の上に金めっき0.76μmMIN
4. めっき：リテンションレグとコンタクト半田付部：ニッケル下地の上にスズめっき

4 3	1-177665-3
4 2	1-177665-2
(FINISH)	製品番号 (PART NO.)

LTR	REVISION RECORD	DR	CHK	DATE
A	REVISED(FJD0-0039-03)	TS	SM	'93 9/30
0	RELEASED (FJ00-0284-93)	NM	SM	'93 9/30

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Tyco Electronics AMP K.K.
Kawasaki,Japan

WIRE RANGE	INSULATION DIA
mm²(AWG -)	- mm
MATERIAL: SEE NOTE 注記参照	FINISH: SEE NOTE 注記参照
DR. 20 SEP 93 N.Matsubara	DE. 20 SEP 93 N.Matsubara
CHK. 30 SEP 93 S.MAHABE	APP. 30 SEP 93 S.MAHABE

NAME: 5 POS SINGLE ROW SMT TYPE VERTICAL HDR ASS'Y FOR DYNAMIC 3100

一般公差 (GENERAL TOLERANCE)
10未満 : ±0.2
10以上30未満 : ±0.3
30以上100未満 : ±0.4
角度 : ±3°

SIZE	LOC	NUMBER
A3	J	C-177665

SCALE	REV.	SHEET
2-1	A	1 OF 1

(CUSTOMER DRAWING) 顧客用図面

NUMBER 177665
3rd ANGLE PROJECTION
METRIC
PROJ NO.392-610
DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT
PRINT DIST
AMP-J REV.10/'83

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